imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



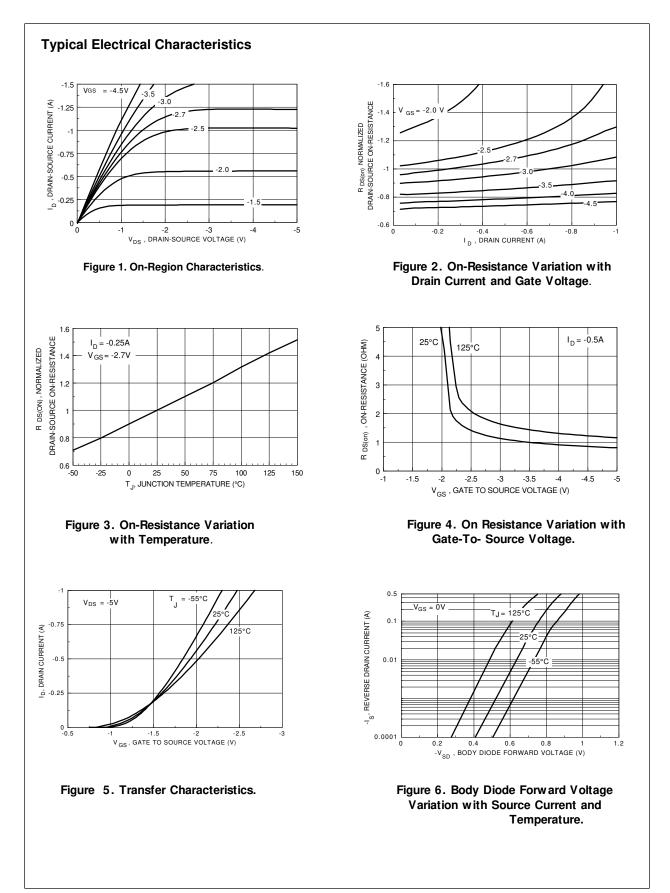
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	CONDUC			August 1997				
FDV3		Channel						
Digita	ai fei, f	P-Channel						
Genera	al Descriptio	n		Features				
This P-Channel enhancement mode field effect transistors is produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is tailored to minimize on-state resistance at low gate drive conditions. This device is designed especially for application in battery power applications such as notebook computers and cellular phones. This device has excellent on-state resistance even at gate drive voltages as low as 2.5 volts.				 -25 V, -0.46 A continuous, -1.5 A Peak. R_{DS(ON)} = 1.1 Ω @ V_{GS} = -4.5 V R_{DS(ON)} = 1.5 Ω @ V_{GS} = -2.7 V. Very low level gate drive requirements allowing direct operation in 3V circuits. V_{GS(th)} < 1.5V. Gate-Source Zener for ESD ruggedness. >6kV Human Body Model 				
				 Compact industry standard SOT-23 surface mount package. 				
			SuperSOT [™] -8	SO-8	SOT-223	SOIC-16		
	DT-23 rk:304	SuperSOT [™] -6	SuperSOT -8					
		SuperSOT [™] -6	Supersol -s					
Absolu	rk:304	D G SOT-23	Supersol -s					
Mar Absolu	rk:304 ute Maximi Parameter	D G SOT-23 $T_A = 2$	s		G S	Units		
Mar Absolu Symbol	ute Maximu Parameter Drain-Source	D G SOT-23 C SOT-23 C G C	s		P G S FDV304P -25			
Mar Absolu Symbol / _{oss}	rk:304 ute Maximi Parameter	D G SOT-23 Comparison G G G $T_A = 2$ E E Voltage E Voltage	S S		G S	Units V		
Mar Absolu Symbol (DSS (GSS	rk:304 rk:304 Ute Maximu Parameter Drain-Source Gate-Source	D G SOT-23 Comparison G G G $T_A = 2$ E E Voltage E Voltage	S S		D G S FDV304P -25 -8	Units U V V V		
Absolu Symbol Cass	rk:304 rk:304 Ute Maximu Parameter Drain-Source Gate-Source Drain Curre	D G SOT-23 um Ratings $T_A = 2$ $T_A = 2$	S S		D G S FDV304P -25 -8 -0.46	Units U V V V		
Absolu aymbol (bss (ass b) b	rk:304 rk:304 Parameter Drain-Source Gate-Source Drain Curre Maximum P	D G SOT-23 Continue T _A = 2 T	S S		D G FDV304P -25 -8 -0.46 -1.5	Units V A		
Absoli Symbol /oss /oss 	rk:304 rk:304 Parameter Drain-Source Gate-Source Drain Curre Maximum P Operating a Electrostatic Human Boc	D G SOT-23 G um Ratings $T_A = 2$ ve Voltage G e Voltage G e Voltage G ower Dissipation G nd Storage Temperature Continue Conscience Rating MIL G Model (100pf / 1500 G	S S 25°C unless other wise note		D G S FDV304P S -25 -8 -0.46 -1.5 0.35 0.35	Units V V V A W		
Absoli Symbol V _{DSS} V _{GSS} D D D D D D D D D D D D D D D D D D	rk:304 rk:304 Parameter Drain-Source Gate-Source Drain Curre Maximum P Operating a Electrostatic Human Boc	D G SOT-23 G um Ratings $T_A = 2$ ve Voltage G e Voltage G e Voltage G ower Dissipation G nd Storage Temperature Continue Conscience Rating MIL G Model (100pf / 1500 G	S S S S S S S S S S S S S S S S S S S		D G S G S FDV304P S -25 -8 -0.46 -1.5 0.35 -55 to 150	Units Units V V A W C C C		

OFF CHAR	Parameter	Conditions	Min	Тур	Max	Units
	ACTERISTICS			1		
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-25			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = -250 μ A, Referenced to 25 °C		-22		mV /° C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -20 V, V_{GS} = 0 V$			-1	μA
555		T ₁ = 55°C			-10	μA
I _{GSS}	Gate - Body Leakage Current	$V_{GS} = -8 V, V_{DS} = 0 V$			-100	nA
	CTERISTICS (Note)	46 56			1	
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_{\rm D}$ = -250 μ A, Referenced to 25 °C		2.1		mV /° C
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	-0.65	-0.86	-1.5	V
GS(th) R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{\rm GS} = -2.7 \text{ V}, \ I_{\rm D} = -0.25 \text{ A}$		1.22	1.5	Ω
DG(ON)		$V_{gs} = -4.5 \text{ V}, \text{ I}_{D} = -0.5 \text{ A}$		0.87	1.1	22
		T, =125°C		1.21	2	
I _{D(ON)}	On-State Drain Current	$V_{GS} = -2.7 \text{ V}, V_{DS} = -5 \text{ V}$	-0.5			А
D(ON)		$V_{gs} = -4.5 \text{ V}, V_{Ds} = -5 \text{ V}$	-1			-
9 _{FS}	Forward Transconductance	$V_{\rm DS} = -5 \text{ V}, \text{ I}_{\rm D} = -0.5 \text{ A}$		0.8		S
	CHARACTERISTICS				1	
C _{iss}	Input Capacitance	$V_{\rm DS} = -10 \text{ V}, \ V_{\rm GS} = 0 \text{ V},$		63		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		34		pF
C _{rss}	Reverse Transfer Capacitance			10		pF
	G CHARACTERISTICS (Note)			1		
D(on)	Turn - On Delay Time	$V_{DD} = -6 V, I_{D} = -0.5 A,$		7	20	ns
r	Turn - On Rise Time	$V_{\rm GS}$ = -4.5 V, $R_{\rm GEN}$ = 50 Ω		8	20	ns
D(off)	Turn - Off Delay Time			55	110	ns
t f	Turn - Off Fall Time			35	70	ns
Qg	Total Gate Charge	$V_{DS} = -5 V, I_{D} = -0.25 A,$ $V_{GS} = -4.5 V$		1.1	1.5	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		0.32		nC
Q _{gd}	Gate-Drain Charge			0.25		nC
DRAIN-SOL	JRCE DIODE CHARACTERISTICS AND MAX	KIMUM RATINGS				
S	Maximum Continuous Drain-Source Diode Forward Current				-0.5	A
V _{sD}	Drain-Source Diode Forward Voltage	$V_{\rm GS} = 0 \ V, \ I_{\rm S} = -0.5 \ A \ ({\rm Note})$		-0.89	-1.2	V



FDV304P Rev.E1

